

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Jun HARIMA</td> <td>07/29/2009</td> </tr> <tr> <td>Masakatsu KONNO</td> <td>07/29/2009</td> </tr> <tr> <td>Ryo HASHINO</td> <td>07/29/2009</td> </tr> <tr> <td>Akira NUMATA</td> <td>07/29/2009</td> </tr> </tbody> </table>		Name	Execution Date	Jun HARIMA	07/29/2009	Masakatsu KONNO	07/29/2009	Ryo HASHINO	07/29/2009	Akira NUMATA	07/29/2009
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<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>Nitto Denko Corporation</td> </tr> <tr> <td>Street Address:</td> <td>1-2, Shimohozumi 1-chome, Ibaraki-shi,</td> </tr> <tr> <td>City:</td> <td>Osaka</td> </tr> <tr> <td>State/Country:</td> <td>JAPAN</td> </tr> <tr> <td>Postal Code:</td> <td>567-8680</td> </tr> </table>		Name:	Nitto Denko Corporation	Street Address:	1-2, Shimohozumi 1-chome, Ibaraki-shi,	City:	Osaka	State/Country:	JAPAN	Postal Code:	567-8680
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CORRESPONDENCE DATA											
Fax Number: (202)721-8250 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i> Phone: 2027218200 Email: wlp@wenderoth.com Correspondent Name: Janae Johnson Address Line 1: 1030 15th Street NW Address Line 2: Suite 400 East Address Line 4: Washington, DISTRICT OF COLUMBIA 20005											
ATTORNEY DOCKET NUMBER:	2009-1325A										
NAME OF SUBMITTER:	Janae Johnson										

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PATENT
REEL: 023157 FRAME: 0051

Total Attachments: 2
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ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned

Insert Name(s) of Inventor(s) Jun HARIMA, Masakatsu KONNO, Ryo HASHINO and Akira NUMATA
the undersigned hereby sell(s) and assign(s) to

Insert Name(s) of Assignee(s) Nitto Denko Corporation
of 1-2, Shimohozumi 1-chome, Ibaraki-shi, Osaka 567-8680 Japan
Address (hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as

Title of Invention ADHESIVE PATCH
for which an application for patent in the United States has been executed by the undersigned

Date of Signing of Application on July 29, 2009

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, L.L.P., 1030 15th Street, N.W., Suite 400 East, Washington, D.C. 20005-1503, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date July 29, 2009, Name of the Inventor Jun Harima
Jun HARIMA
Date July 29, 2009, Name of the Inventor Masakatsu Konno
Masakatsu KONNO
Date July 29, 2009, Name of the Inventor Ryo Hashino
Ryo HASHINO
Date July 29, 2009, Name of the Inventor Akira Numata
Akira NUMATA

(This assignment should preferably be acknowledged before a United States Consul. If not, then the execution by the Inventor(s) should be witnessed by at least two witnesses who sign here.)

Witness Takeshi Fujisawa
Takeshi FUJISAWA
Witness _____

ACKNOWLEDGMENT

_____) ss

This _____ day of _____, 20____, before me personally came the above-named me personally known as the individual(s) who executed the foregoing assignment, who did acknowledge to me that he (they) executed the same of his (their) own free will for the purposes therein set forth.

SEAL

Official Signature

Official Title

The above application may be more particularly identified as follows:

U.S. Application Serial No. _____ Filing Date _____
Applicant Reference Number _____ Atty Docket No. _____
Title of Invention _____
